

# Surface Mount Limiter, 2.9 – 3.3 GHz

## LM2933-Q-B-301 Datasheet

### Features

- Surface Mount Limiter in Compact Package:  
8 mm L x 5 mm W x 2.5 mm H
- Incorporates PIN Limiter Diodes, DC Blocks, Schottky Diode & DC Return
- Frequency Range (2.9 GHz to 3.3 GHz)
- Higher Peak Power Handling than Plastic-Packaged Limiters (1.6 kW Peak)
- Higher Average Power Handling than Plastic-Packaged Limiters (100 W CW)
- Very Low Insertion Loss (0.6 dB)
- Low Flat Leakage Power (23 dBm)
- RoHS Compliant



  
A passion for performance.



### Applications

- Receiver protection
- LNA protection

### Description

The LM2933-Q-B-301 Surface Mount Silicon PIN Diode Limiter is a surface mount, passive two-stage power limiter which can operate over the frequency range of 2.9 GHz to 3.3 GHz. It is manufactured using Aeroflex-Metelics proven hybrid manufacturing process incorporating PIN Diodes and passive devices integrated onto a ceramic substrate. This low profile, compact, (8 mm L x 5 mm W x 2.5 mm H) surface mount component offers outstanding small and large signal performance. This product is designed for optimal small signal insertion loss for very low receiver noise figure and excellent large-input-signal flat leakage power for effective receiver protection from 2.9 GHz to 3.3 GHz.

The very low thermal resistance (20 °C/W, junction to bottom surface of package) of the PIN diodes in this device and the presence of a Schottky detector bias current source enables it to reliably handle RF incident power levels up to 47 dBm CW and RF peak incident power levels up to 62 dBm (70 µs pulse width, 3% duty cycle). The I layer thickness of the output stage and the design of the internal Schottky detector current source combine to produce flat leakage of 23 dBm typical and spike leakage energy of 0.25 ergs, typical. No external control signals are required. This limiter module includes internal DC blocking capacitors in the RF signal path, as well as an internal DC return path.

### Environmental Capabilities

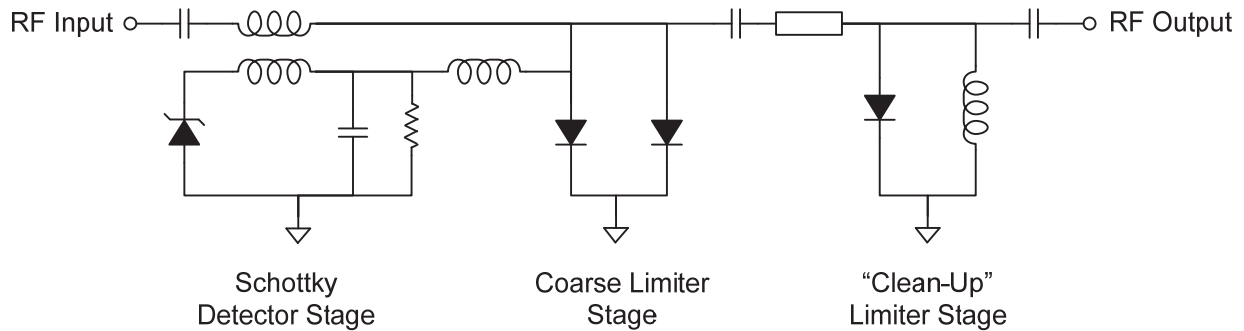
The LM2933-Q-B-301 limiter is compatible with high volume, surface mount, solder re-flow manufacturing methods. This product is durable and capable of reliably operating in military, commercial, and industrial environments. The device is RoHS compliant and is available in tube or tape-reel. The LM2933-Q-B-301 limiter is capable of meeting the environmental requirements of MIL-STD-750 and MIL-STD-202.

### ESD and Moisture Sensitivity Level Rating

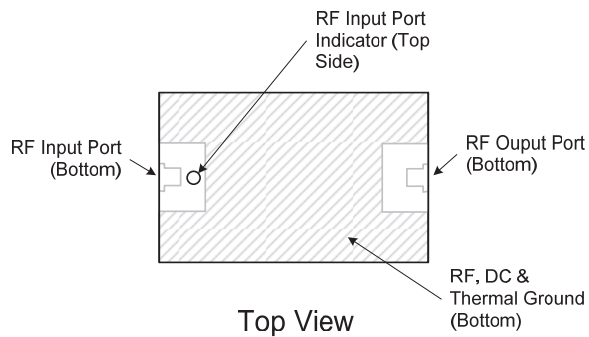
As are all semiconductor devices, PIN diode limiters are susceptible to damage from ESD events. The ESD rating for this device is Class 0 (HBM). The moisture sensitivity level rating for this device is MSL 1.



## Limiter Schematic



## Pinout



## Electrical Specifications

@  $Z_0 = 50 \Omega$ ,  $T_A = +25 \text{ }^\circ\text{C}$ , as measured in Aeroflex evaluation board (Unless Otherwise Defined)

Parameter	Symbol	Test Conditions	Minimum Value	Typical Value	Maximum Value	Units
Frequency	F	$2.9 \text{ GHz} \leq F \leq 3.3 \text{ GHz}$	2.5	---	3.5	GHz
Insertion Loss	IL	$2.9 \text{ GHz} \leq F \leq 3.3 \text{ GHz}$ , $P_{in} = 0 \text{ dBm}$	---	0.6	0.7	dB
Return Loss	RL	$2.9 \text{ GHz} \leq F \leq 3.3 \text{ GHz}$ , $P_{in} = 0 \text{ dBm}$	14	15	---	dB
Input 1 dB Compression Point	$IP_{1dB}$	$1 \text{ GHz} \leq F \leq 2 \text{ GHz}$	7	8	10	dBm
2nd Harmonic	$2F_0$	$P_{in} = 0 \text{ dBm}$ , $F_0 = 3.0 \text{ GHz}$	---	-50	-45	dBc
Peak Incident Power	$P_{inc(Pk)}$	RF Pulse Width = 70 $\mu\text{s}$ , duty cycle = 3%	---	---	62	dBm
Peak Incident Power	$P_{inc(Pk)}$	RF Pulse Width = 40 $\mu\text{s}$ , duty cycle = 10%	---	---	57	dBm
CW Incident Power	$P_{inc(CW)}$	$1 \text{ GHz} \leq F \leq 2 \text{ GHz}$	---	---	47	dBm
Flat Leakage Power	FL	RF Pulse Width = 70 $\mu\text{s}$ , duty cycle = 3%	---	23	24	dBm
Spike Leakage Energy	SL	$P_{in} = 53 \text{ dBm}$ peak, RF pulse width = 70 $\mu\text{s}$ , duty cycle = 3%	---	0.25	0.3	erg
Recovery Time	$T_R$	50% falling edge of RF pulse to 1 dB IL, $P_{in} = 53 \text{ dBm}$ peak, RF pulse width = 70 $\mu\text{s}$ , duty cycle = 3%	---	1.5	2.0	$\mu\text{s}$

## Absolute Maximum Ratings

@  $Z_0 = 50 \Omega$ ,  $T_A = +25 \text{ }^\circ\text{C}$ , as measured in Aeroflex evaluation board (Unless Otherwise Defined)

Parameter	Conditions	Absolute Maximum Value
Operating Temperature		- 65 °C to 125 °C
Storage Temperature		- 65 °C to 125 °C
Junction Temperature		175 °C
RF CW Incident Power	$T_{\text{case}} = 85 \text{ }^\circ\text{C}$ , source and load VSWR < 1.2:1, derate linearly to 0 W at $T_{\text{case}} = 150 \text{ }^\circ\text{C}$ (note 1)	47 dBm
RF Peak Incident Power	$T_{\text{case}} = 85 \text{ }^\circ\text{C}$ , source and load VSWR < 1.2:1, RF pulse width = 70 $\mu\text{s}$ , duty cycle = 3%	62 dBm
$\Theta_{\text{jc}}$ Thermal Resistance	Junction to bottom surface of package	25 °C/W
Assembly Temperature		260 °C for 30 Seconds

Notes:

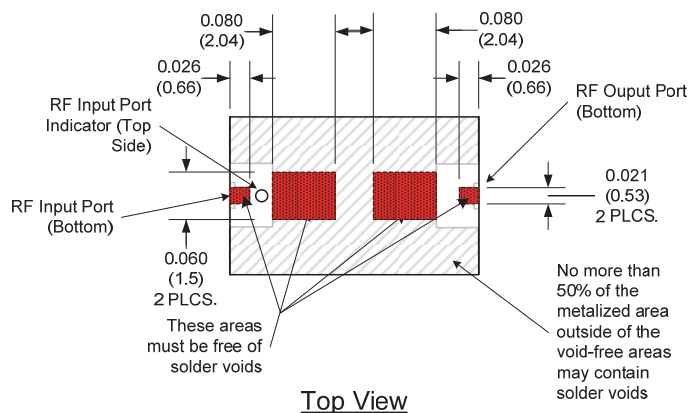
1.  $T_{\text{case}}$  is defined as the temperature of the bottom surface of the package.

## Criteria for Proper Mounting on PCB

When a large signal is incident upon the input of the LM2933-Q-B-301, the impedance of the coarse limiter diodes is forced to a low value by the charge which is injected into these diodes by the combination of the current from the internal detector stage and the large RF voltage initially present across these diodes. As the impedance of these diodes decreases, an increasingly large impedance mismatch with the impedance of the transmission line to which the limiter is connected is created. Ultimately, the impedance of the coarse limiter diodes is reduced to a few ohms. This mismatch creates a standing wave, with a current maximum located at the position of the coarse limiter diodes. While the large majority of the input signal power is reflected back to its source due to the impedance mismatch, the significant RF current that flows at the current maximum causes Joule heating to occur in the coarse limiter diodes, so there must be a path with minimal thermal resistance from the coarse diodes to the external system heat sink. Also, there must be a minimal electrical resistance and inductance between the underside of the limiter module package and the system ground in order to achieve maximum RF isolation between the input and the output of the limiter module.

For these reasons, it is imperative that there are no voids in the electrical and thermal paths directly under the coarse limiter diodes. Care must be taken when mounting the LM2933-Q-B-301 to avoid voids in the solder joint in the area along the lengthwise axis of the package, under and between the filled vias in the AlN substrate of the module, which are shown in the diagram (above). It is also important to ensure no solder voids exist between the limiter module RF ports and the PCB to which the limiter module is attached.

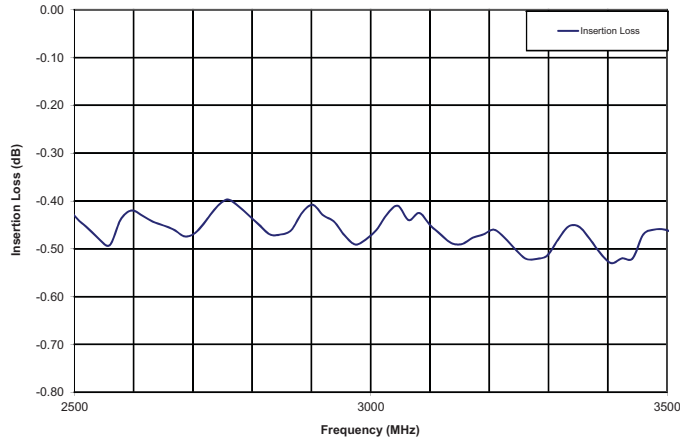
No greater than 50% of the remaining metalized area on the bottom of the package may contain solder voids.



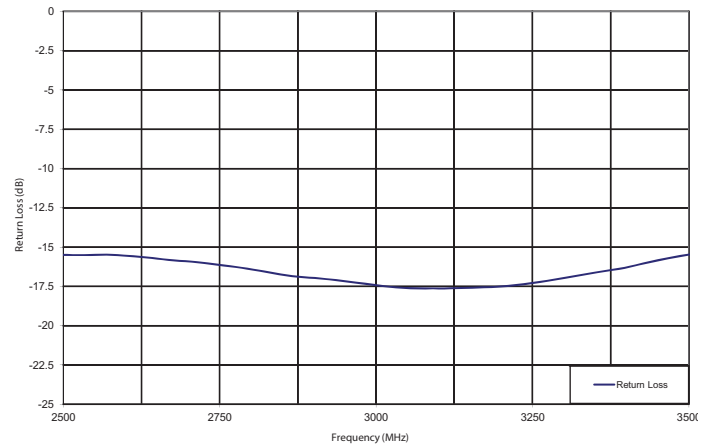
Dimensions in inches (mm).

## Typical Performance

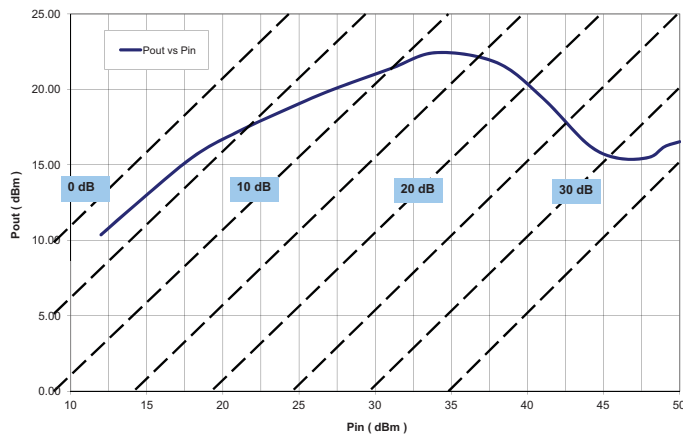
$Z_0 = 50 \Omega$ ,  $T_A = 25 \text{ }^\circ\text{C}$ ,  $P_{IN} = 0 \text{ dBm}$ , as measured in the Aeroflex / Metelics evaluation board, unless otherwise noted



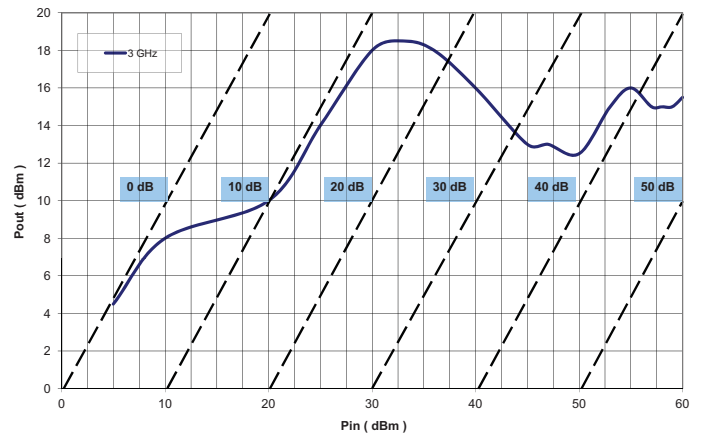
**Insertion Loss vs. Frequency**



**Return Loss vs. Frequency**



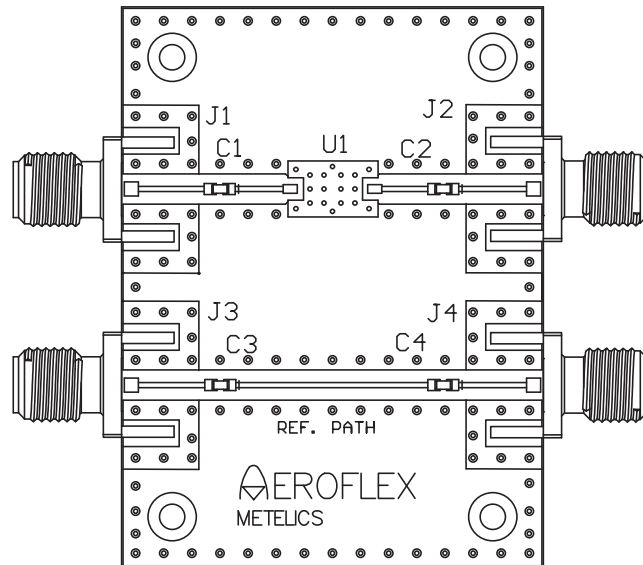
**CW Output Power vs. CW Input Power**



**Flat Leakage Output Power vs. Input Power,  
Pulse width = 70  $\mu\text{s}$ , Duty Cycle = 3%,  $f = 3 \text{ GHz}$**

# PIN Diode Limiter

## Evaluation Board



The evaluation board for the LM2933-Q-B-301 is shown above. This evaluation board comprises two sections: the evaluation circuit for the LM2933-Q-B-301 limiter module; and a reference transmission line.

The limiter module is mounted in position U1. Its RF input is connected to J1 and its output port is connected to J2, via two 50  $\Omega$  microstrip transmission lines.

Since the LM2933-Q-B-301 contains internal DC blocking capacitors in its input and output ports, the components mounted in the positions marked C1, C2, C3 and C4 are 0  $\Omega$  resistors.

The reference path 50  $\Omega$  microstrip transmission line structure can be utilized to determine the insertion loss of the transmission line structures connected between J1 and the limiter module input, as well as between the limiter module output and J2, so that their respective insertion losses may be subtracted from the total insertion loss measured between J1 and J2. This enables the resolution of the insertion loss of the limiter module only.

The evaluation board is supplied mounted on a heat sink. The maximum RF input power specified in the Absolute Maximum Ratings table must not be exceeded.

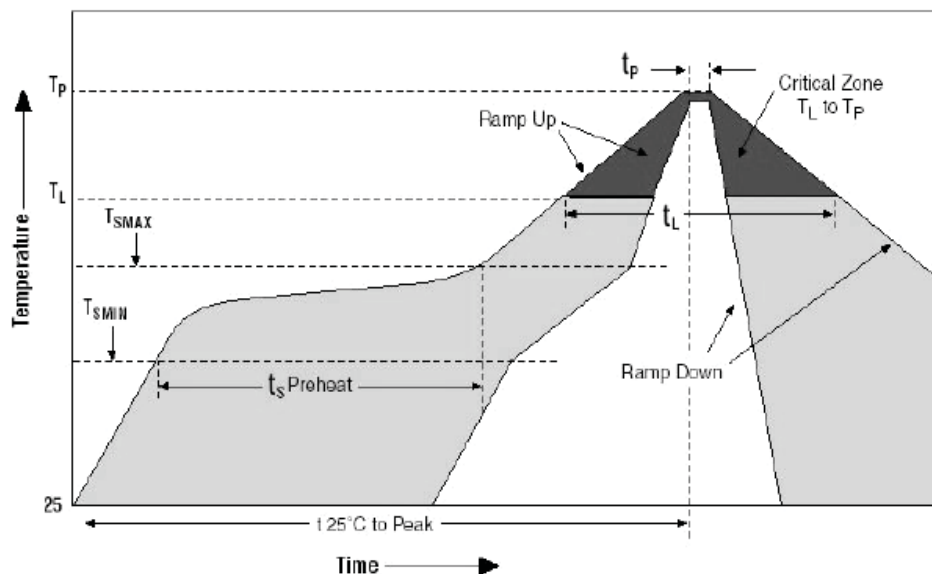
## Assembly Instructions

The LM2933-Q-B-301 limiter is capable of being placed onto a circuit board by pick-and-place manufacturing equipment from tube or tape-reel dispensing. The device is attached to the circuit board using conventional solder re-flow or wave soldering procedures with RoHS type or Sn60/Pb40 type solders per the recommended time-temperature profile shown below.

Table 1: Time-Temperature Profile for Sn 60/Pb40 or RoHS Type Solders

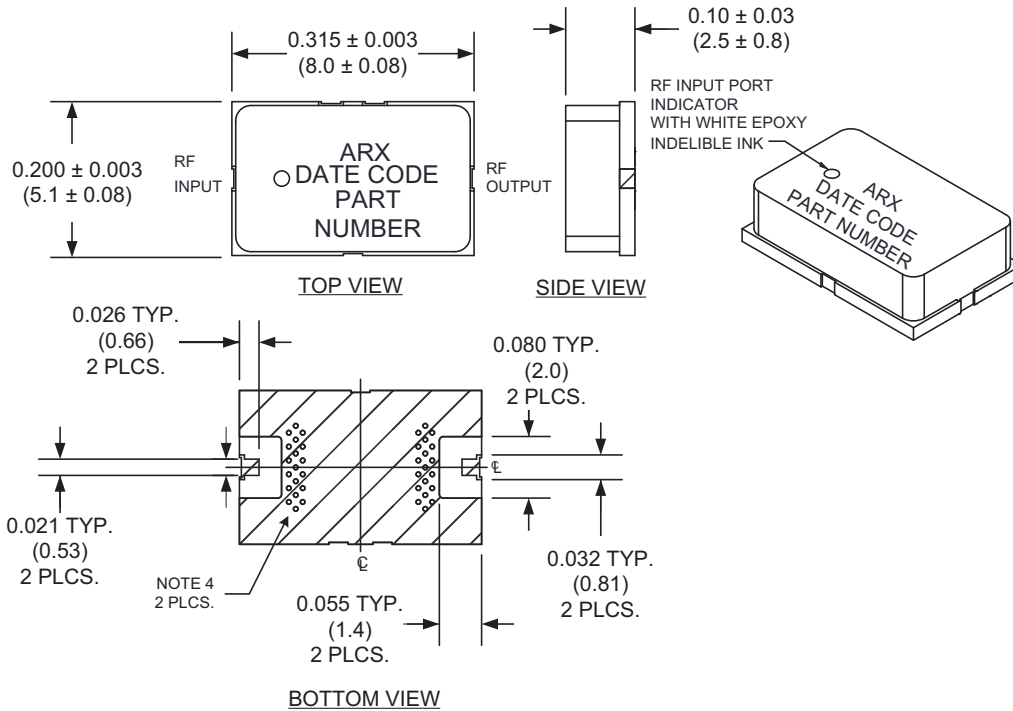
Profile Feature	Sn-Pb Solder Assembly	Pb-Free Solder Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3 °C/second maximum	3 °C/second maximum
Preheat <ul style="list-style-type: none"> <li>- Temperature Minimum (T<sub>S MIN</sub>)</li> <li>- Temperature Maximum (T<sub>S MAX</sub>)</li> <li>- Time (Minimum to maximum) (t<sub>S</sub>)</li> </ul>	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds
T <sub>S MAX</sub> to T <sub>L</sub> <ul style="list-style-type: none"> <li>- Ramp-up Rate</li> </ul>		3 °C/second maximum
Time Maintained above: <ul style="list-style-type: none"> <li>- Temperature (T<sub>L</sub>)</li> <li>- Time (t<sub>L</sub>)</li> </ul>	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (T <sub>P</sub> )	225 +0 / -5 °C	260 +0/-5 °C
Time within 5°C of actual Peak Temperature (T <sub>P</sub> )	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second maximum	6 °C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

## Solder Re-Flow Time-Temperature Profile



# PIN Diode Limiter

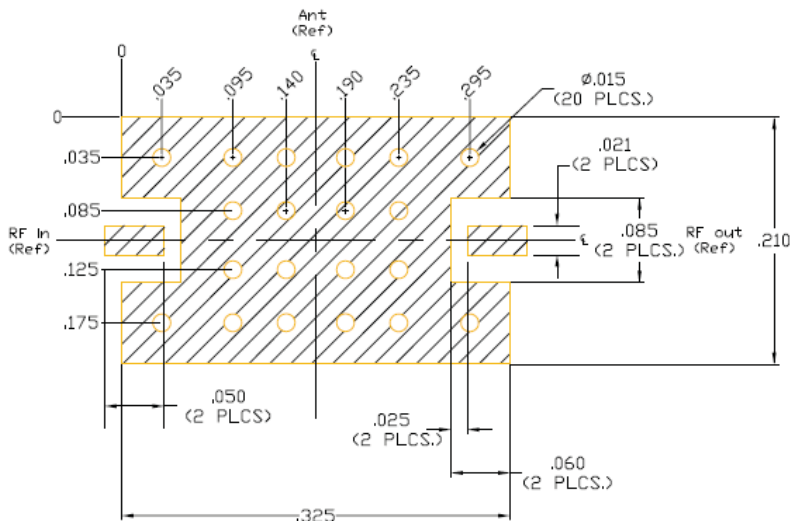
## Outline Drawing, Case Style 301, (CS301)



### NOTES:

1. Substrate material: 20 mil thick aluminum nitride (AlN)
2. RF cover: black ceramic
3. Top side and back side metalization: 0.5  $\mu$ m typical plated Au over Ti-Pd.
4. Locations and numbers of plated through vias are for reference only.

## RF Circuit Solder Footprint for Case Style 301 (CS 301)



### Notes:

1. Recommended PCB material is Rogers 4350, 10 mils THK.
2. Hatched area is RF, DC, and thermal ground. Vias should be solid copper filled and gold plated for optimum heat transfer from backside of limiter module through circuit vias to thermal ground.

## Part Number Ordering Information:

Part Number	Description
LM2933-Q-B--301-T	Tube Packaging
LM2933-Q-B--301-R	Tape-Reel Packaging Quantities of 250 or 500
LM2933-Q-B-301-W	Waffle Packaging
LM2933-Q-B-301-E	RF Evaluation Board

### Aeroflex / Metelics, Inc.

54 Grenier Field Road, Londonderry, NH 03053  
 Tel: (603) 641-3800  
 Sales: (888) 641-SEMI (7364)  
 Fax: (603)-641-3500

975 Stewart Drive, Sunnyvale, CA 94085  
 Tel: (408) 737-8181  
 Fax: (408) 733-7645

[www.aeroflex.com/metelics](http://www.aeroflex.com/metelics)      [metelics-sales@aeroflex.com](mailto:metelics-sales@aeroflex.com)

Aeroflex / Metelics, Inc. reserves the right to make changes to any products and services herein at any time without notice. Consult Aeroflex or an authorized sales representative to verify that the information in this data sheet is current before using this product. Aeroflex does not assume any responsibility or liability arising out of the application or use of any product or service described herein, except as expressly agreed to in writing by Aeroflex; nor does the purchase, lease, or use of a product or service from Aeroflex convey a license under any patent rights, copyrights, trademark rights, or any other of the intellectual rights of Aeroflex or of third parties.

Copyright 2012 Aeroflex / Metelics. All rights reserved.

ISO 9001:2008 certified companies



Our passion for performance is defined by three attributes represented by these three icons: solution-minded, performance-driven and customer-focused.